

SBOS230A - MARCH 2002 - REVISED JUNE 2002

# **4-Channel Audio Volume Control**

#### **FEATURES**

- DIGITALLY-CONTROLLED ANALOG VOLUME CONTROL:
  - Four Independent Audio Channels Serial Control Interface Zero Crossing Detection Mute Function
- WIDE GAIN AND ATTENUATION RANGE:
   +31.5dB to -95.5dB with 0.5dB Steps
- LOW NOISE AND DISTORTION: 120dB Dynamic Range 0.0004% THD+N at 1kHz (U-Grade) 0.0002% THD+N at 1kHz (A-Grade)
- NOISE-FREE LEVEL TRANSITIONS
- LOW INTERCHANNEL CROSSTALK: –130dBFS
- POWER SUPPLIES: ±5V Analog, +5V Digital
- AVAILABLE IN AN SOP-28 PACKAGE

#### **APPLICATIONS**

- AUDIO AMPLIFIERS
- MIXING CONSOLES
- MULTI-TRACK RECORDERS
- BROADCAST STUDIO EQUIPMENT
- MUSICAL INSTRUMENTS
- EFFECTS PROCESSORS
- A/V RECEIVERS
- CAR AUDIO SYSTEMS

#### **DESCRIPTION**

The PGA4311 is a high–performance, 4-channel audio volume control designed for professional and high-end consumer audio systems. Using high performance operational amplifier stages internal to the PGA4311 yields low noise and distortion, while providing the capability to drive  $600\Omega$  loads directly without buffering. The 3-wire serial control interface allows for connection to a wide variety of host controllers, in addition to support for daisy-chaining of multiple PGA4311 devices.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.





# ABSOLUTE MAXIMUM RATINGS(1)

Supply Voltage, VA++5.5V
V <sub>A</sub> 5.5V
V <sub>D</sub> + +5.5V
$V_A$ + to $V_D$ +
Analog Input Voltage 0V to V <sub>A</sub> +, V <sub>A</sub> -
Digital Input Voltage
Operating Temperature Range –40°C to +85°C
Storage Temperature Range65°C to +150°C
Junction Temperature
Lead Temperature (soldering, 10s) +300°C
Package Temperature (IR reflow, 10s) +235°C

 Stresses above these ratings may cause permanent damage. Exposure to absolute maximum conditions for extended periods may degrade device reliability.

# ELECTROSTATIC DISCHARGE SENSITIVITY

This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

#### PACKAGE/ORDERING INFORMATION

PRODUCT	PACKAGE-LEAD	PACKAGE DESIGNATOR <sup>(1)</sup>	OPERATING TEMPERATURE RANGE	PACKAGE MARKING	ORDERING NUMBER	TRANSPORT MEDIA, QUANTITY	
DCA4244 (III Crade)	SOP-28	DW	-40°C to +85°C	PGA4311U	PGA4311U	Rails	
PGA4311 (U-Grade)		DVV	-40°C 10 +65°C	PGA4311U	PGA4311U/1K	Tape and Reel, 1000	
DCA 4044 (A. C	SOP-28	DW	4000 +- +0500	PGA4311UA	PGA4311UA	Rails	
PGA4311 (A-Grade)			–40°C to +85°C	PGA4311UA	PGA4311UA/1K	Tape and Reel, 1000	

<sup>(1)</sup> For the most current specifications and package information, refer to our web site at www. ti.com.

#### **ELECTRICAL CHARACTERISTICS**

At  $T_A = +25^{\circ}C$ ,  $V_A + = +5V$ ,  $V_A - = -5V$ ,  $V_D + = +5V$ ,  $R_I = 100k\Omega$ ,  $C_I = 20pF$ , BW measure = 10Hz to 20kHz, unless otherwise noted.

DADAMETER	CONDITIONS	PGA4311U (U-Grade)			PGA4311UA (A-Grade)			LINUTO
PARAMETER	CONDITIONS	MIN	TYP	MAX	MIN	TYP	MAX	UNITS
DC CHARACTERISTICS								
Step Size			0.5			0.5		dB
Gain Error	Gain Setting = 31.5dB		±0.05			±0.05		dB
Gain Matching			±0.05			±0.05		dB
Input Resistance			10			10		kΩ
Input Capacitance			3			3		pF
AC CHARACTERISTICS								
THD+N	$V_{IN} = 2V_{rms}, f = 1kHz$		0.0004	0.001		0.0002	0.0004	%
Dynamic Range	V <sub>IN</sub> = AGND, Gain = 0dB	116	120		116	120		dB
Voltage Range, Output		(V <sub>A</sub> –) + 1.25		(V <sub>A</sub> +) – 1.25	(V <sub>A</sub> –) + 1.25		(V <sub>A</sub> +) – 1.25	V
Voltage Range, Input (without clipping)			2.5			2.5		Vrms
Output Noise	V <sub>IN</sub> = AGND, Gain = 0dB		2.5	4		2.5	4	μVrms
Interchannel Crosstalk	f = 1kHz		-130			-130		dBFS
OUTPUT BUFFER								
Offset Voltage	V <sub>IN</sub> = AGND, Gain = 0dB		0.25	0.5		0.25	0.5	mV
Load Capacitance Stability			100			100		pF
Short–Circuit Current			50			50		mA
Unity-Gain Bandwidth, Small Signal			10			10		MHz

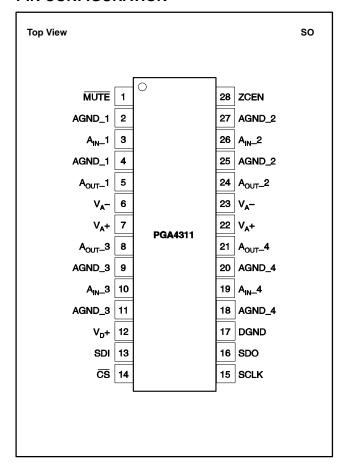


 $\begin{tabular}{ll} \textbf{ELECTRICAL CHARACTERISTICS (Cont.)} \\ \textbf{At T}_{A} = +25^{\circ}\text{C}, \ V_{A}+ = +5\text{V}, \ V_{D}+ = +5\text{V}, \ R_{L} = 100\text{k}\Omega, \ C_{L} = 20\text{pF}, \ \text{BW measure} = 10\text{Hz to 20kHz}, \ \text{unless otherwise noted}. \\ \end{tabular}$ 

		PGA	PGA4311U (U-Grade)			PGA4311UA (A-Grade)		
PARAMETER	CONDITIONS	MIN	TYP	MAX	MIN	TYP	MAX	UNITS
DIGITAL CHARACTERISTICS								
High-Level Input Voltage, VIH		+2.0		V <sub>D</sub> +	+2.0		V <sub>D</sub> +	V
Low-Level Input Voltage, V <sub>IL</sub>		-0.3		0.8	-0.3		0.8	V
High–Level Output Voltage, V <sub>OH</sub>	I <sub>O</sub> = 200μA	(V <sub>A</sub> +) – 1.0			(V <sub>D</sub> +) – 1.0			V
Low-Level Output Voltage, VOI	$I_{O} = -3.2 \text{mA}$			0.4			0.4	V
Input Leakage Current	-		1	10		1	10	μΑ
SWITCHING CHARACTERISTICS								
Serial Clock (SCLK) Frequency	fSCLK	0		6.25	0		6.25	MHz
Serial Clock (SCLK) Pulse Width LOW	t <sub>PH</sub>	80			80			ns
Serial Clock (SCLK) Pulse Width HIGH	tpL	80			80			ns
MUTE Pulse Width LOW	t <sub>MI</sub>	2.0			2.0			ms
Input Timing								
SDI Setup Time	tsds	20			20			ns
SDI Hold Time	t <sub>SDH</sub>	20			20			ns
CS Falling to SCLK Rising	tCSCR	90			90			ns
SCLK Falling to CS Rising	tCFCS	35			35			ns
Output Timing	0.00							
CS LOW to SDO Active	tcso			35			35	ns
SCLK Falling to SDO Data Valid	tCFDO			60			60	ns
CS HIGH to SDO High Impedance	tCSZ			100			100	ns
POWER SUPPLY								
Operating Voltage								
V <sub>A</sub> +		+4.75	+5	+5.25	+4.75	+5	+5.25	V
V <sub>A</sub> -		-4.75	-5	-5.25	-4.75	<b>-</b> 5	-5.25	V
V <sub>D</sub> +		+4.75	+5	+5.25	+4.75	+5	+5.25	V
Quiescent Current								
I <sub>A</sub> +	$V_{A}$ + = +5 $V$		17	22		17	22	mA
I <sub>A</sub> -	$V_{A} - = -5V$		19	24		19	24	mA
I <sub>D</sub> +	$V_{D}$ + = +5 $V$		0.5	1.0		0.5	1.0	mA
Power-Supply Rejection Ratio PSRR (250Hz)			100			100		dB
TEMPERATURE RANGE								
Operating Range		-40		+85	-40		+85	°C
Storage Range		-65		+150	-65		+150	°C



# **PIN CONFIGURATION**



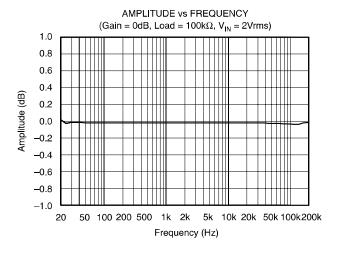
# **PIN ASSIGNMENTS**

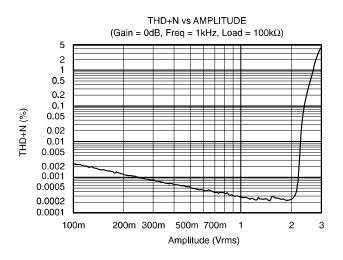
PIN	NAME	FUNCTION		
1	MUTE	Mute Control Input (Active LOW)		
2	AGND_1	Analog Ground, Channel 1		
3	A <sub>IN</sub> _1	Analog Input, Channel 1		
4	AGND_1	Analog Ground, Channel 1		
5	A <sub>OUT</sub> _1	Analog Output, Channel 1		
6	V <sub>A</sub> -	Analog Power Supply, –5V		
7	V <sub>A</sub> +	Analog Power Supply, +5V		
8	AOUT_3	Analog Output, Channel 3		
9	AGND_3	Analog Ground, Channel 3		
10	A <sub>IN</sub> _3	Analog Input, Channel 3		
11	AGND_3	Analog Ground, Channel 3		
12	∨ <sub>D</sub> +	Digital Power Supply, +5V		
13	SDI	Serial Data Input		
14	CS	Chip Select Input		
15	SCLK	Serial Clock Input		
16	SDO	Serial Data Output		
17	DGND	Digital Ground		
18	AGND_4	Analog Ground, Channel 4		
19	A <sub>IN</sub> _4	Analog Input, Channel 4		
20	AGND_4	Analog Ground, Channel 4		
21	A <sub>OUT</sub> _4	Analog Output, Channel 4		
22	V <sub>A</sub> +	Analog Power Supply, +5V		
23	V <sub>A</sub> -	Analog Power Supply, –5V		
24	A <sub>OUT</sub> _2	Analog Output, Channel 2		
25	AGND_2	Analog Ground, Channel 2		
26	A <sub>IN</sub> _2	Analog Input, Channel 2		
27	AGND_2	Analog Ground, Channel 2		
28	ZCEN	Zero Crossing Enable (Active HIGH)		

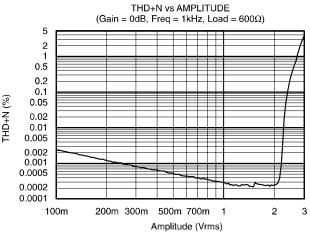


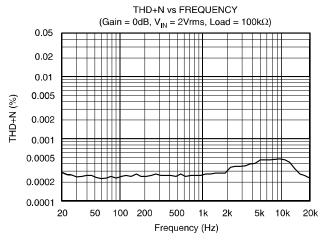
#### **TYPICAL CHARACTERISTICS**

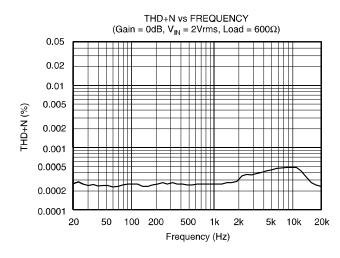
At  $T_A = +25^{\circ}C$ ,  $V_A + = +5V$ ,  $V_A - = -5V$ ,  $V_D + = +5V$ ,  $R_L = 100k\Omega$ ,  $C_L = 20pF$ , BW measure = 10Hz to 20kHz, unless otherwise noted. (NOTE: All plots taken with PGA4311 A–Grade.)

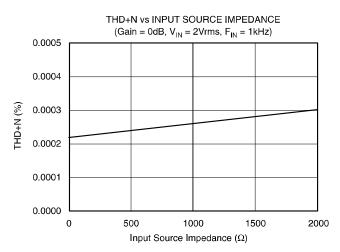








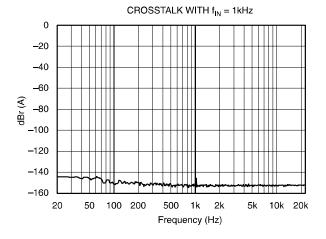


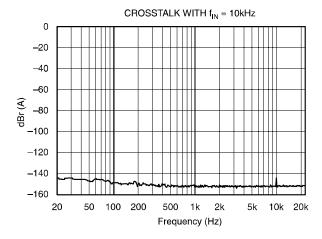


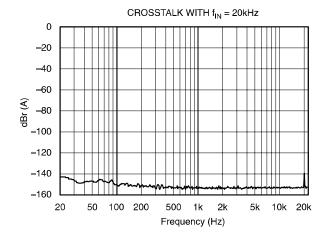


## **TYPICAL CHARACTERISTICS (Cont.)**

At  $T_A = +25^{\circ}C$ ,  $V_A + = +5V$ ,  $V_A - = -5V$ ,  $V_D + = +5V$ ,  $R_L = 100k\Omega$ ,  $C_L = 20pF$ , BW measure = 10Hz to 20kHz, unless otherwise noted. (NOTE: All plots taken with PGA4311 A–Grade.)







# **GENERAL DESCRIPTION**

The PGA4311 is a four-channel audio volume control. It may be used in a wide array of professional and consumer audio equipment. The PGA4311 is fabricated in a sub-micron CMOS process.

The heart of the PGA4311 is a resistor network, an analog switch array, and a high-performance op amp stage. The switches are used to select taps in the resistor network that, in turn, determine the gain of the amplifier stage. Switch selections are programmed using a serial control port. The serial port allows connection to a wide variety of host controllers. See Figure 1 for a functional block diagram of the PGA4311.

### **POWER-UP STATE**

On power up, "power-up reset" is activated for about 100ms during which the circuit is in hardware MUTE state and all internal flip-flops are reset. At the end of this period, the offset calibration is initiated without any external signals. Once this has been completed, the gain byte value for all channels are set to  $00_{HEX}$ , or the software MUTE condition. The gain will remain at this setting until the host controller programs new settings for for each channel via the serial control port.



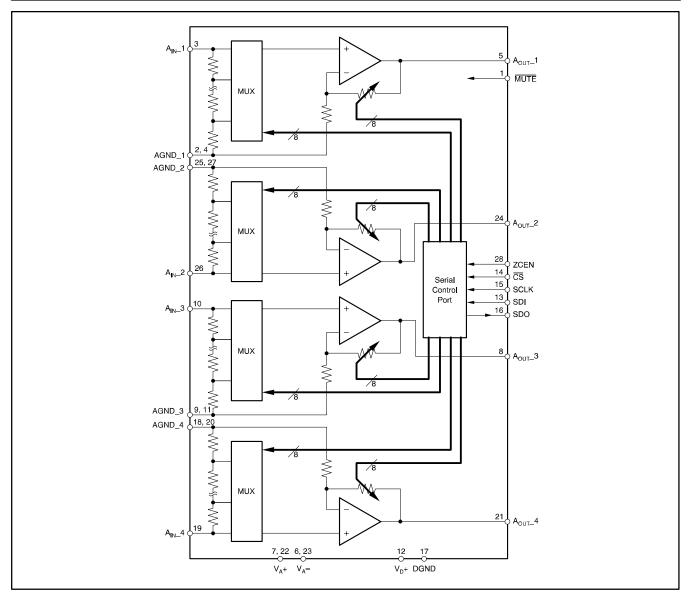


Figure 1. PGA4311 Block Diagram.

If during normal operation the power supply voltage drops below  $\pm 3.2$ V, the circuit enters a hardware  $\overline{\text{MUTE}}$  state. A power-up sequence will be initiated if the power-supply voltage returns to greater than  $\pm 3.2$ V.

#### **ANALOG INPUTS AND OUTPUTS**

The PGA4311 includes four independent channels. Each channel has a corresponding input and output pin. The input and output pins are unbalanced, and referenced to analog ground.

The input and output pins may swing within 1.25V of the analog power supplies,  $V_A+$  and  $V_A-$ . Given  $V_A+=+5V$  and  $V_A-=-5V$ , the maximum input or output voltage range is 7.5Vp-p.

For optimal performance, it is best to drive the PGA4311 with a low source impedance. A source impedance of  $600\Omega$  or less is recommended. Source impedances up to  $2k\Omega$  will cause minimal degradation of THD+N. Please refer to the "THD+N vs Source Impedance" plot in the Typical Characteristics section of the datasheet.



#### **SERIAL CONTROL PORT**

The serial control port is utilized to program the gain settings for the PGA4311. The serial control port includes three input pins and one output pin. The inputs include  $\overline{CS}$  (pin 14), SDI (pin 13), and SCLK (pin 15). The sole output pin is SDO (pin 16).

The  $\overline{\text{CS}}$  pin functions as the chip select input. Data may be written to the PGA4311 only when  $\overline{\text{CS}}$  is LOW. SDI is the serial data input pin. Control data is provided as a 32-bit word at the SDI pin, 8 bits each for each channel gain setting.

Data is formatted as MSB first, straight binary code. SCLK is the serial clock input. Data is clocked into SDI on the rising edge of SCLK.

SDO is the serial data output pin, and is used when daisy-chaining multiple PGA4311 devices. Daisy-chain operation is described in detail later in this section. SDO is a tri-state output, and assumes a high impedance state when  $\overline{\text{CS}}$  is HIGH. Data appears at SDO on the falling edge of SCLK.

The protocol for the serial control port is shown in Figure 2. See Figure 3 for detailed timing specifications for the serial control port.

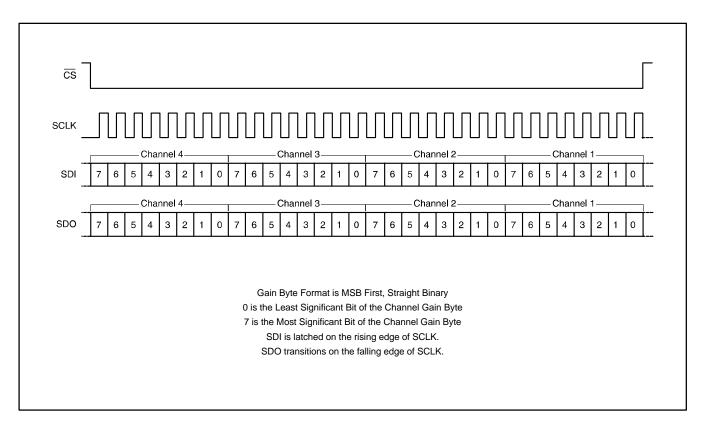


Figure 2. Serial Interface Protocol.



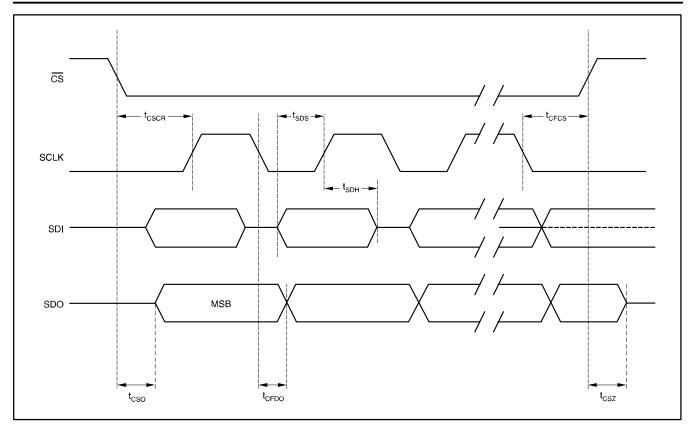


Figure 3. Serial Interface Timing Requirements.

#### **GAIN SETTINGS**

The gain for each channel is set by its corresponding 8-bit code, [7:0] (see Figure 2). The gain code data is straight binary format. If we let N equal the decimal equivalent of [7:0], then the following relationships exist for the gain settings:

For N = 0:

Mute Condition. The input multiplexer is connected to analog ground.

For N = 1 to 255:

Gain (dB) = 31.5 - [0.5 w (255 - N)]

This results in a gain range of +31.5dB (with N = 255) to -95.5dB (with N = 1).

Changes in gain setting may be made with or without zero crossing detection. The operation of the zero crossing detector and timeout circuitry is discussed later in this data sheet.



#### DAISY-CHAINING MULTIPLE PGA4311 DEVICES

In order to reduce the number of control signals required to support multiple PGA4311 devices on a printed circuit board, the serial control port supports daisy-chaining of multiple PGA4311 devices. Figure 4 shows the connection requirements for daisy-chain operation. This arrangement allows a 3-wire serial interface to control many PGA4311 devices.

As shown in Figure 4, the SDO pin from device #1 is connected to the SDI input of device #2, and is repeated for additional devices. This in turn forms a large shift register, in which gain data may be written for all PGA4311s connected to the serial bus. The length of the shift register is 32 • N bits, where N is equal to the number of PGA4311 devices included in the chain. The  $\overline{\text{CS}}$  input must remain LOW for 32 • N SCLK periods, where N is the number of devices connected in the chain, in order to allow enough SCLK cycles to load all devices.

#### ZERO CROSSING DETECTION

The PGA4311 includes a zero crossing detection function that can provide for noise-free level transitions. The concept is to change gain settings on a zero crossing of the input signal, thus minimizing audible glitches. This function is enabled or disabled using the ZCEN input. When ZCEN is LOW, zero crossing detection is disabled. When ZCEN is HIGH, zero crossing detection will be enabled.

The zero crossing detection takes effect with a change in gain setting for a corresponding channel. The new gain setting will not be implemented until either positive slope zero crossing is detected or a time-out period of 16ms has elapsed. In the case of a time-out, the new gain setting takes effect with no attempt to minimize audible artifacts.

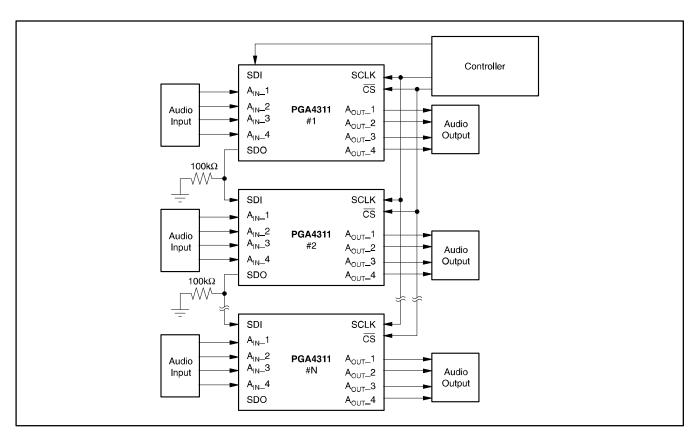


Figure 4. Daisy-Chaining Multiple PGA4311 Devices.



#### **MUTE FUNCTION**

Muting can be achieved by either hardware or software control. Hardware muting is accomplished via the MUTE input, and software muting by loading all zeroes into the volume control register.

 $\overline{\text{MUTE}}$  disconnects the internal buffer amplifiers from the output pins and terminates the outputs with 10kΩ resistors to ground. The mute is activated with a zero crossing detection (independent of the zero cross enable status) or an 16ms time-out to eliminate any audible "clicks" or "pops".  $\overline{\text{MUTE}}$  also initiates an internal offset calibration.

A software mute is implemented by loading all zeroes into the volume control register. The internal amplifier is set to unity gain with the amplifier input connected to AGND.

# APPLICATIONS INFORMATION

This section includes additional information that is pertinent to designing the PGA4311 into an end application.

#### RECOMMENDED CONNECTION DIAGRAM

Figure 5 depicts the recommended connections for the PGA4311. Power-supply bypass capacitors should be placed as close to the PGA4311 package as physically possible.

### PRINTED CIRCUIT BOARD (PCB) LAYOUT GUIDE-LINES

It is recommended that the ground planes for the digital and analog sections of the PCB be separate from one another. The planes should be connected at a single point. See Figure 6 for the recommended PCB floor plan for the PGA4311.

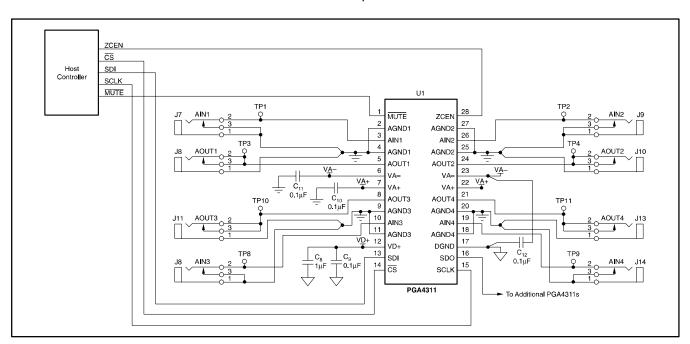


Figure 5. Recommended Connection Diagram.



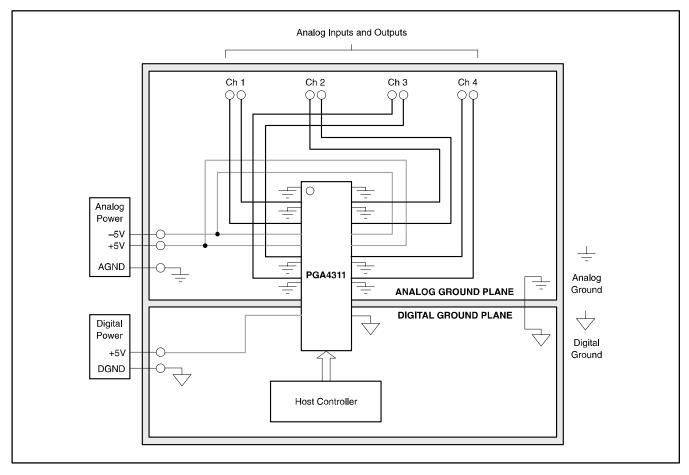


Figure 6. Typical PCB Layout Floor Plan.



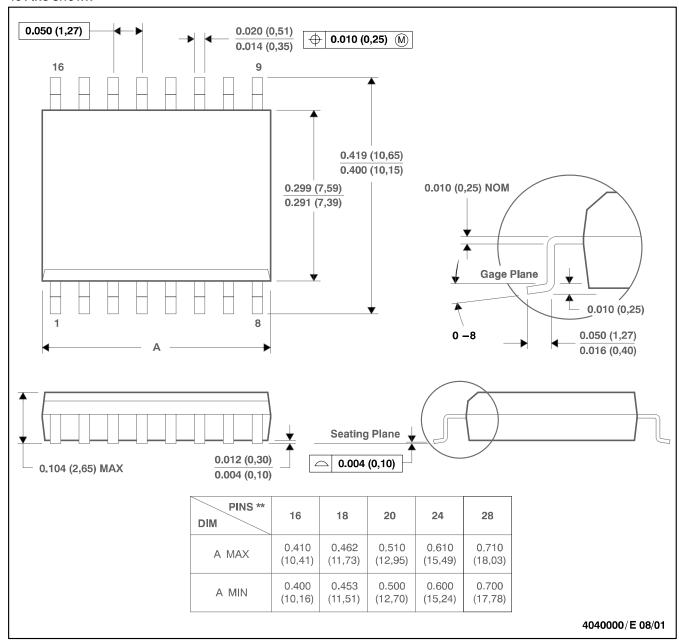
#### **PACKAGE DRAWING**

#### MSOI003E - JANUARY 1995 - REVISED SEPTEMBER 2001

# DW (R-PDSO-G\*\*)

# PLASTIC SMALL-OUTLINE PACKAGE

#### **16 PINS SHOWN**



- NOTES: A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  - C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
  - D. Falls within JEDEC MS-013

#### **IMPORTANT NOTICE**

Texas Instruments Incorporated and its subsidiaries (TI) reserve the right to make corrections, modifications, enhancements, improvements, and other changes to its products and services at any time and to discontinue any product or service without notice. Customers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All products are sold subject to TI's terms and conditions of sale supplied at the time of order acknowledgment.

TI warrants performance of its hardware products to the specifications applicable at the time of sale in accordance with TI's standard warranty. Testing and other quality control techniques are used to the extent TI deems necessary to support this warranty. Except where mandated by government requirements, testing of all parameters of each product is not necessarily performed.

TI assumes no liability for applications assistance or customer product design. Customers are responsible for their products and applications using TI components. To minimize the risks associated with customer products and applications, customers should provide adequate design and operating safeguards.

TI does not warrant or represent that any license, either express or implied, is granted under any TI patent right, copyright, mask work right, or other TI intellectual property right relating to any combination, machine, or process in which TI products or services are used. Information published by TI regarding third—party products or services does not constitute a license from TI to use such products or services or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

Reproduction of information in TI data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. Reproduction of this information with alteration is an unfair and deceptive business practice. TI is not responsible or liable for such altered documentation.

Resale of TI products or services with statements different from or beyond the parameters stated by TI for that product or service voids all express and any implied warranties for the associated TI product or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements.

Mailing Address:

Texas Instruments Post Office Box 655303 Dallas, Texas 75265

Copyright © 2002, Texas Instruments Incorporated